

# TCA9802 I<sup>2</sup>C Buffer Evaluation Module

The TCA9802EVM evaluation module (EVM) allows the user to connect power to and buffer and translate I<sup>2</sup>C commands to the onboard slave device, TMP102. The EVM allows the designer to load and test different capacitive loading and has the option of replacing a series resistor with an inductor to emulate the parasitic inductance of cables. Parameters such as rise time, power consumption, and delay times can easily and accurately be evaluated. For additional details on I<sup>2</sup>C buffer performance, application notes, and the data sheet, see <a href="https://www.ti.com/l2C">www.ti.com/l2C</a>.

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4	Example: USB2ANY I <sup>2</sup> C Master Connected to the TCA9802EVM

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Introduction www.ti.com

## 1 Introduction

The TCA9802EVM allows designers to evaluate and compare device performance to enable fast selection of I²C buffers and translators for their system. The TCA9802EVM contains the TCA9802 along with a linear regulator, TPS71701, and I²C temperature sensors, TMP102. There are other buffers that can be ordered as samples but are not loaded with the EVM (TCA9800, TCA9801, TCA9803, or TCA9517A). This allows the designer to evaluate the entire family of devices along with competitor solutions.

## 1.1 Overview

The TCA9802 is a dual-channel bidirectional buffer intended for I<sup>2</sup>C bus and SMBus or PMBus systems. It provides bidirectional level shifting (up-translation and down-translation) between low voltages (down to 0.8 V) and higher voltages (1.65 V to 3.6 V). The TCA9802 features an internal current source on the B-side of the device, allowing the removal of external pull-up resistors on the B-side. The current source also provides an improved rise time and ultra-low power consumption.

### 1.2 EVM Features

This EVM has the following features:

- V<sub>CCA</sub> input voltage range: 0.8 V to 3.6 V
- V<sub>CCB</sub> input voltage range: 1.65 V to 3.6 V
- Access to the V<sub>CCA</sub>, V<sub>CCB</sub>, OE, SDAA, SCLA, SDAB, and SCLB pins
- Onboard slave device, TMP102, that is programmed using jumpers
- Onboard V<sub>CCB</sub> regulator, TPS71701, that is programmed using a jumper
- Dual layout to allow for evaluating and comparing competitors or other TCA980x family of devices
- · Footprints to test various capacitive loads and series inductance to emulate real-world parasitic affects

## 2 EVM Hardware Block Diagram and Images

The TCA9802EVM is an evaluation module for the Texas Instruments TCA9802 and TCA980x family of I<sup>2</sup>C buffers. It provides basic functionality evaluation for the device. Figure 1 illustrates the EVM schematic.



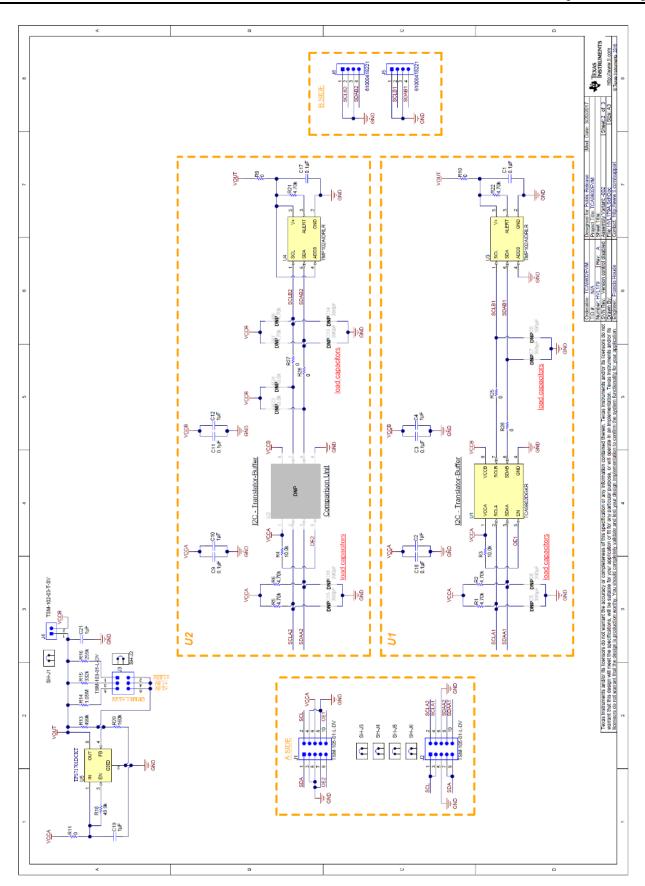


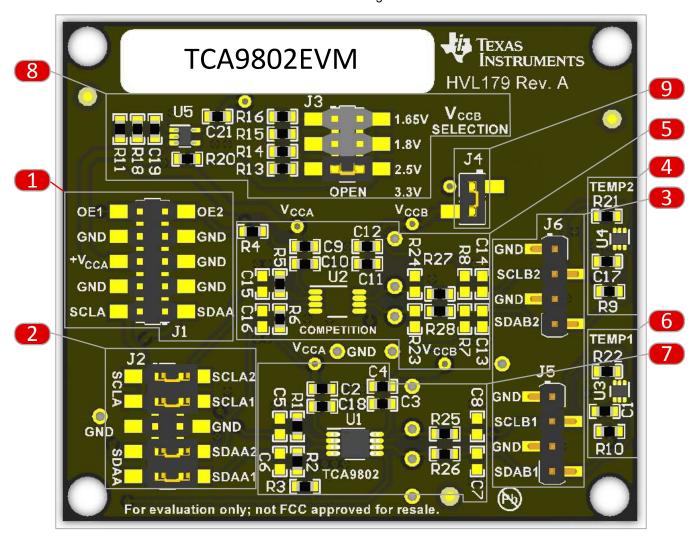
Figure 1. TCA9802EVM Schematic



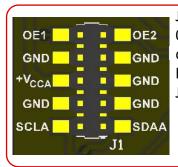
Hardware Description www.ti.com

## 3 Hardware Description

The TCA9802 EVM is designed to allow the user to easily evaluate the I<sup>2</sup>C buffer for a variety of conditions. The breakdown of all the features and design of the EVM follow:





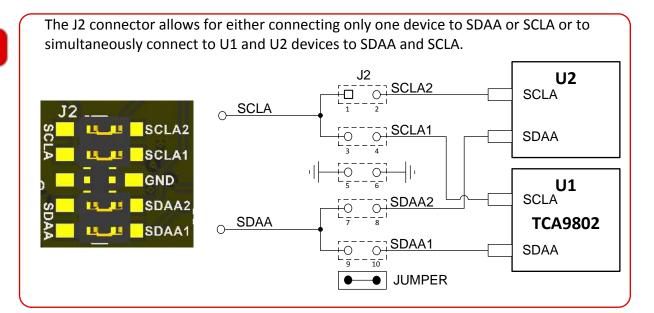


J1 is the connector designed to be mated with any  $I^2C$  master via 0.100" headers. J1 allows for power connection (+ $V_{CCA}$ ), ground connection, OE1 for U1, OE2 for U2, SDA, and SCL data lines. U2 is by default loaded with TCA9802. Connect + $V_{CCA}$  to the EVM using J1-6.

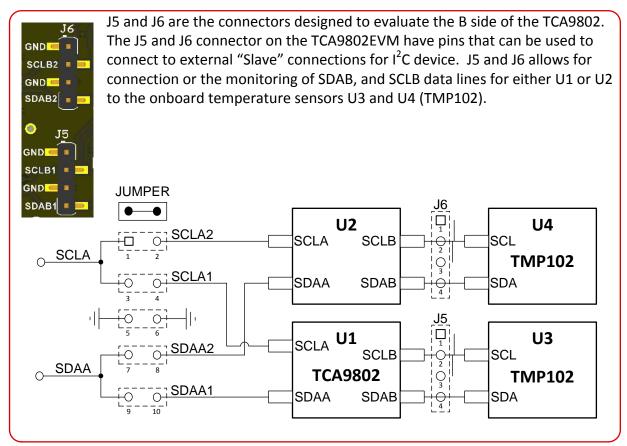


www.ti.com Hardware Description

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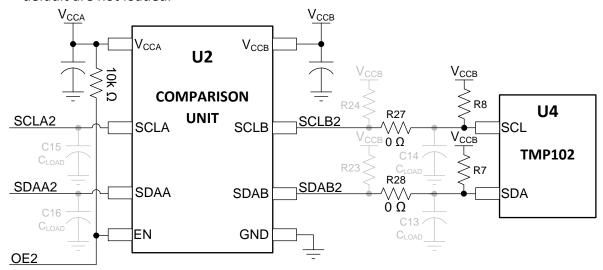


TEMP2 is the  $I^2C$  controlled temperature sensor (TMP102) connected to the U2 device. The V+ of the temperature sensor is connected to  $V_{OUT}$  of the TPS71701 linear regulator. Its  $I^2C$  address is 0x49h.

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U2 is the device that can be used to compare to the TCA9802, which is in the U1 location. U2 has the same layout as the U1 location, with the exception that the B side has pull resistor footprints to allow for comparison with the traditional  $I^2C$  buffers such as the TCA9517, which require external pullups. There are also place holders for series resistors (R27 and R28) and capacitive loads (C13 and C14). R27 and R28 are by default  $0-\Omega$  resistors, but can be replaced with chip inductors, if the user wishes to emulate parasitic inductance. There are two sets of pullup resistors that can be loaded, but the default configuration is that neither are loaded, thus allowing for immediate testing of other TCA980x family devices. The two locations allow for testing of systems that have either the pullups close to U2 or pullups close to the slave device, this assumes that a chip inductor is loaded to emulate a meaningful amount of inductance.

C15 and C16 are placeholders for capacitive loading of the input waveforms, which by default are not loaded.



The EVM has also been setup to be able to directly probe onto the SCLB2 and SDAB2. There are large vias that facilitate the scope probe tips and probe ground connections. This was designed to minimize the ground loop to minimize noise being picked up by the probe. This allows for capturing clean waveforms. NOTE: If evaluating a device such as the TCA9517 at U2, calculate the appropriate pullup resistor and load them on to the desired pullup resistor location on the B side of the device.



www.ti.com Hardware Description

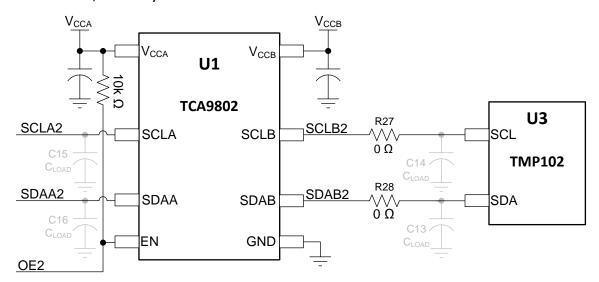
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TEMP1 is the  $I^2$ C controlled temperature sensor (TMP102) at U3 that is connected to the U1 device. The V+ of the temperature sensor is connected to  $V_{OUT}$  of the TPS71701 linear regulator. The  $I^2$ C address of U3 is 0x48h.

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The TCA9802 is loaded in the U1 location. The TCA9802 or any of the TCA980x devices do not need and in fact must **not** have pullup resistors on the B side of the device. Pullup resistors will affect the operation of the device. There are also place holders for series resistors (R25 and R26) and capacitive loads (C7 and C8). R25 and R26 are by default  $0-\Omega$  resistors, but can be replaced with chip inductors, if emulating the parasitic inductance of a wiring harness. C5 and C6 are placeholders for capacitive loading of the input waveforms, which by default are not loaded.



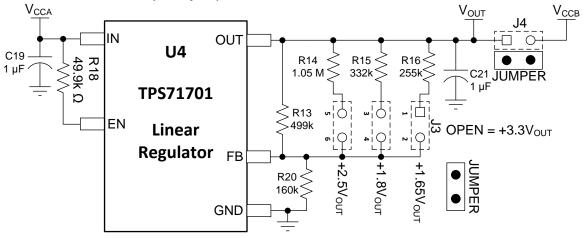
The EVM has also been setup to be able to directly probe onto the SCLB1 and SDAB1. There are large vias that facilitate the scope probe tips and probe ground connections. This was designed to reduce the ground loop to minimize noise being picked up by the probe. This allows for capturing clean waveforms.



Hardware Description www.ti.com

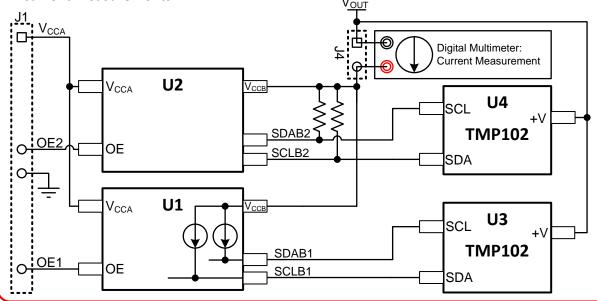
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The TCA9802 EVM has an onboard linear regulator that controls  $V_{CCB}$ .  $V_{OUT}$  is connected directly to the V+ supply rail of the TMP102A (U5 and U6), which decouples the current draw from  $V_{CCB}$ . The J4 jumper allows the designer to insert a current meter and measure the current being consumed by the either U1, U2, or both.  $V_{OUT}$  is 3.3 V if there is no jumper placed on J3.  $V_{OUT}$  is 2.5 V if the jumper is placed across J3-5 and J3-6, 1.8 V if the jumper is placed across J3-3 and J3-4, and 1.65 V if the jumper is placed across J3-1 and J3-2. NOTE: Place only one jumper on J3 at a time.



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The TCA9802EVM was designed so that  $V_{CCB}$ , the buffered side, can have the input current measured for comparative analysis. This is generally done with a digital multimeter using J4 as the connection point. The OE pin for both U1 and U2 can be controlled independently therefore allowing for comparative analysis between the two. The  $I^2C$  temperature sensor, U3 and U4, have their supply on  $V_{OUT}$ , therefore not affecting  $V_{CCB}$  current measurements.





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## 4 Layout

Figure 2 and Figure 3 show the PCB layout images.

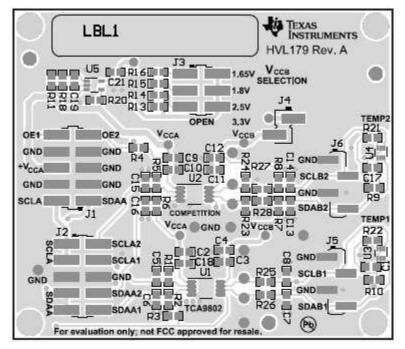


Figure 2. TCA9802EVM Top Layout

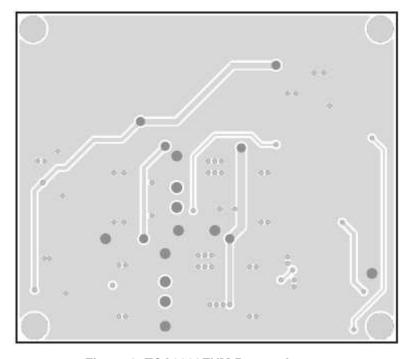


Figure 3. TCA9802EVM Bottom Layout



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## 4.1 Setup

This section describes the setup and operation of the EVM for evaluation performance. Figure 4 shows the configuration for operating the TCA9802 I<sup>2</sup>C buffer using a USB2ANY. An oscilloscope can be connected directly to J1 or the SDA and SCL pins on J5 and J6. Additional large vias for the SCLB, SDAB, and ground are placed on the EVM to facilitate oscilloscope probe tips and scope ground connections. The TCA9802EVM has a dedicated slave peripheral (temperature sensor, TMP102) for each unit, U1 and U2. The temperature sensor of U1 (U3) has an address of 0x48h and sending an I<sup>2</sup>C read command for that address should give you a hex value of approximately 190h, assuming the EVM is at room temperature (25°C). The address of U4 is 0x49h.

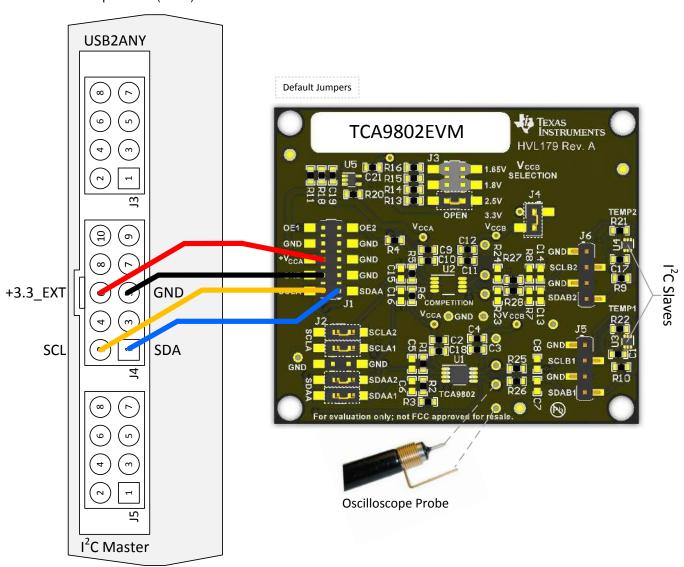


Figure 4. Example: USB2ANY I<sup>2</sup>C Master Connected to the TCA9802EVM

## 4.1.1 J1, A Side Connections

This is the connection for the leads from the  $I^2C$  master source. The signals of the USB2ANY  $I^2C$  master are connected as follows: SDAA = J1-1, SCLA = J1-2, GND = J1-3,4,5,7, or 8, and  $+V_{CCA}$ = J1-6.



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## 4.1.2 J2, A Side SDA and SCL Selection

This connector allows for the decoupling of which device (U1 or U2) gets the SDA and SCL signals. The default is that U1 and U2 have A side signals connected together, which is performed by the four jumpers that are placed across J2-1 and J2-2, J2-3 and J2-4, J2-7 and J2-8, and J2-9 and J2-10.

## 4.1.3 JP3, V<sub>CCB</sub> Selection

This is the  $V_{\text{CCB}}$  voltage selection header, which by default is set to 2.5 V with a jumper placed between the J3-5 and J3-6 location. If no jumper is fitted, then  $V_{\text{CCB}}$  is set to 3.3 V. A shorting jumper must be installed on JP1 in either the high or low position. The TCA9802 is active high, and ON must not be left floating. An external enable source can be applied to the EVM by removing the shunt and connecting a signal to TP2. Refer to the TCA9802 data sheet (SCPS266) for proper ON and OFF voltage level settings. A switching signal may also be used and connected at this point.

## 4.1.4 J4, V<sub>CCB</sub> Test Header

J4 allows for placing an external supply on J4-2 or for placing a meter in series to measure current coming from the supply. J4 is loaded with a jumper by default.

## 4.1.5 J5 and J6, B Side Connections

These are probe connections to the B side SDA and SCL, which also go to the TMP102 temperature sensor slave devices, U3 and U4. They can also be used to connect an external slave device.

## 4.1.6 SDA, SCL, and GND Test Points

These are additional large vias to facilitate connections to the B side SDA, SCL, and GND. Figure 5 shows a variety of large vias that either allow for probing of signals or they can also be used to install test points.

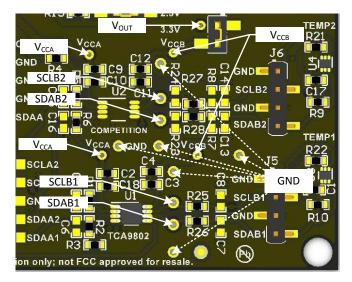


Figure 5. Vias Labeled on the TCA9802EVM

## 5 Operation

This EVM was specifically designed to translate and buffer the communication between an I<sup>2</sup>C master with the TMP102 I<sup>2</sup>C temperature sensor. Temperature sensor U3 has an I<sup>2</sup>C address of 0x48 and temperature sensor U4 has an I<sup>2</sup>C address of 0x49. Instructions on how to communicate with the TMP102 temperature sensor are found in the TMP102 data sheet (SBOS397).



Bill of Materials (BOM) www.ti.com

## 6 Bill of Materials (BOM)

Table 1 lists the EVM BOM.

## Table 1. Bill of Materials TCA9802EVM

Qty	Designator	Value	Description	Package Reference	Manufacturer	Part Number
1	!PCB		Printed Circuit Board		Any	HVL179
6	C2, C4, C10, C12, C19, C21	1uF	CAP, CERM, 1 μF, 16 V, ±10%, X5R, 0603	0603	Murata	GRM188R71E105KA12D
6	C1, C3, C9, C11, C17, C18	0.1uF	CAP, CERM, 0.1 μF, 25 V, ±10%, X7R, 0603	0603	Murata	GRM188R72A104KA35J
1	LBL1		thermal Transfer Printable Labels, 1.250" x 0.250"		Brady	THT-13-457-10
2	J1, J2		Header, 2.54mm, 5x2, Gold, SMT	Header, 2.54mm, 5x2, SMT	Samtec	TSM-105-01-L-DV
1	JP3		Header, 2.54mm, 3x2, Gold, SMT	Header, 2.54mm, 3x2, SMT	Samtec	TSM-103-01-L-DV
1	JP4		Header, 2.54mm, 2x1, Tin, SMT	Header, 2.54mm, 2x1, SMT	Samtec	TSM-102-03-T-SV
2	J5, J6		Header, 2.54mm, 4x1, Gold, SMT	Header, 2.54mm, 4x1, SMT	Wurth Elektronik	61000418221
6	R1, R2, R5, R6, R21, R22	4.70k	RES, 4.70 k, 1%, 0.1 W, 0603	0603	Yageo America	RC0603FR-074K7L
2	R3, R4	10.0k	RES, 10.0 k, 1%, 0.1 W, 0603	0603	Vishay-Dale	CRCW060310K0FKEA
7	R9, R10, R11, R25, R26, R27, R28	0	RES, 0, 5%, 0.1 W, 0603	0603	Vishay-Dale	CRCW06030000Z0EA
1	R13	499k	RES, 499 k, 1%, 0.1 W, 0603	0603	Vishay-Dale	CRCW0603499KFKEA
1	R14	1.05Meg	RES, 1.05 M, 1%, 0.1 W, 0603	0603	Vishay-Dale	CRCW06031M05FKEA
1	R15	332k	RES, 332 k, 1%, 0.1 W, 0603	0603	Vishay-Dale	CRCW0603332KFKEA
1	R16	255k	RES, 255 k, 1%, 0.1 W, 0603	0603	Vishay-Dale	CRCW0603255KFKEA
1	R18	49.9k	RES, 49.9 k, 1%, 0.1 W, 0603	0603	Vishay-Dale	CRCW060349K9FKEA
1	R20	160k	RES, 160 k, 1%, 0.1 W, 0603	0603	Vishay-Dale	CRCW0603160KFKEA
6	SH-J1, SH-J2, SH-J3, SH-J4, SH-J5, SH-J6	1x2	Shunt, 100mil, Gold plated, Black	Shunt	3M	969102-0000-DA
1	U1		LEVEL-TRANSLATING I2C BUS REPEATER, DGK0008A	DGK0008A	Texas Instruments	TCA9802DGKR
2	U3, U4		Low Power Digital Temperature Sensor With SMBus/Two-Wire Serial Interface in SOT563, DRL0006A (SOT-6)	DRL0006A	Texas Instruments	TMP102AIDRLR
1	U5		Single Output LDO, 150 mA, Adjustable 0.9 to 6.2 V Output, 2.5 to 6.5 V Input, with High-Bandwidth PSRR, 5-pin SC70 (DCK)	DCK0005A	Texas Instruments	TPS71701DCKT
0	FID1, FID2, FID3		Fiducial mark. There is nothing to buy or mount.	Fiducial	N/A	N/A

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- 1. Delivery: TI delivers TI evaluation boards, kits, or modules, including any accompanying demonstration software, components, and/or documentation which may be provided together or separately (collectively, an "EVM" or "EVMs") to the User ("User") in accordance with the terms set forth herein. User's acceptance of the EVM is expressly subject to the following terms.
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  - 1.2 EVMs are not intended for consumer or household use. EVMs may not be sold, sublicensed, leased, rented, loaned, assigned, or otherwise distributed for commercial purposes by Users, in whole or in part, or used in any finished product or production system.
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  - 2.3 Tl's sole liability shall be at its option to repair or replace EVMs that fail to conform to the warranty set forth above, or credit User's account for such EVM. Tl's liability under this warranty shall be limited to EVMs that are returned during the warranty period to the address designated by Tl and that are determined by Tl not to conform to such warranty. If Tl elects to repair or replace such EVM, Tl shall have a reasonable time to repair such EVM or provide replacements. Repaired EVMs shall be warranted for the remainder of the original warranty period. Replaced EVMs shall be warranted for a new full ninety (90) day warranty period.
- 3 Regulatory Notices:
  - 3.1 United States
    - 3.1.1 Notice applicable to EVMs not FCC-Approved:

**FCC NOTICE:** This kit is designed to allow product developers to evaluate electronic components, circuitry, or software associated with the kit to determine whether to incorporate such items in a finished product and software developers to write software applications for use with the end product. This kit is not a finished product and when assembled may not be resold or otherwise marketed unless all required FCC equipment authorizations are first obtained. Operation is subject to the condition that this product not cause harmful interference to licensed radio stations and that this product accept harmful interference. Unless the assembled kit is designed to operate under part 15, part 18 or part 95 of this chapter, the operator of the kit must operate under the authority of an FCC license holder or must secure an experimental authorization under part 5 of this chapter.

3.1.2 For EVMs annotated as FCC – FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant:

## **CAUTION**

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

### FCC Interference Statement for Class A EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

### FCC Interference Statement for Class B EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- · Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- · Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

### 3.2 Canada

3.2.1 For EVMs issued with an Industry Canada Certificate of Conformance to RSS-210 or RSS-247

### **Concerning EVMs Including Radio Transmitters:**

This device complies with Industry Canada license-exempt RSSs. Operation is subject to the following two conditions:

(1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

### Concernant les EVMs avec appareils radio:

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

### **Concerning EVMs Including Detachable Antennas:**

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication. This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

## Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante. Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur

### 3.3 Japan

- 3.3.1 Notice for EVMs delivered in Japan: Please see http://www.tij.co.jp/lsds/ti\_ja/general/eStore/notice\_01.page 日本国内に輸入される評価用キット、ボードについては、次のところをご覧ください。
  http://www.tij.co.jp/lsds/ti\_ja/general/eStore/notice\_01.page
- 3.3.2 Notice for Users of EVMs Considered "Radio Frequency Products" in Japan: EVMs entering Japan may not be certified by TI as conforming to Technical Regulations of Radio Law of Japan.

If User uses EVMs in Japan, not certified to Technical Regulations of Radio Law of Japan, User is required to follow the instructions set forth by Radio Law of Japan, which includes, but is not limited to, the instructions below with respect to EVMs (which for the avoidance of doubt are stated strictly for convenience and should be verified by User):

- 1. Use EVMs in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry's Rule for Enforcement of Radio Law of Japan,
- Use EVMs only after User obtains the license of Test Radio Station as provided in Radio Law of Japan with respect to EVMs, or
- 3. Use of EVMs only after User obtains the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to EVMs. Also, do not transfer EVMs, unless User gives the same notice above to the transferee. Please note that if User does not follow the instructions above, User will be subject to penalties of Radio Law of Japan.

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3.3.3 Notice for EVMs for Power Line Communication: Please see http://www.tij.co.jp/lsds/ti\_ja/general/eStore/notice\_02.page 電力線搬送波通信についての開発キットをお使いになる際の注意事項については、次のところをご覧ください。http://www.tij.co.jp/lsds/ti\_ja/general/eStore/notice\_02.page

### 3.4 European Union

3.4.1 For EVMs subject to EU Directive 2014/30/EU (Electromagnetic Compatibility Directive):

This is a class A product intended for use in environments other than domestic environments that are connected to a low-voltage power-supply network that supplies buildings used for domestic purposes. In a domestic environment this product may cause radio interference in which case the user may be required to take adequate measures.

- 4 EVM Use Restrictions and Warnings:
  - 4.1 EVMS ARE NOT FOR USE IN FUNCTIONAL SAFETY AND/OR SAFETY CRITICAL EVALUATIONS, INCLUDING BUT NOT LIMITED TO EVALUATIONS OF LIFE SUPPORT APPLICATIONS.
  - 4.2 User must read and apply the user guide and other available documentation provided by TI regarding the EVM prior to handling or using the EVM, including without limitation any warning or restriction notices. The notices contain important safety information related to, for example, temperatures and voltages.
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    - 4.3.2 EVMs are intended solely for use by technically qualified, professional electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems, and subsystems. User assumes all responsibility and liability for proper and safe handling and use of the EVM by User or its employees, affiliates, contractors or designees. User assumes all responsibility and liability to ensure that any interfaces (electronic and/or mechanical) between the EVM and any human body are designed with suitable isolation and means to safely limit accessible leakage currents to minimize the risk of electrical shock hazard. User assumes all responsibility and liability for any improper or unsafe handling or use of the EVM by User or its employees, affiliates, contractors or designees.
  - 4.4 User assumes all responsibility and liability to determine whether the EVM is subject to any applicable international, federal, state, or local laws and regulations related to User's handling and use of the EVM and, if applicable, User assumes all responsibility and liability for compliance in all respects with such laws and regulations. User assumes all responsibility and liability for proper disposal and recycling of the EVM consistent with all applicable international, federal, state, and local requirements.
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